# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
KEISUKE SAKATA	12/09/2014

### **RECEIVING PARTY DATA**

Name:	EBARA CORPORATION	
Street Address:	11-1, HANEDA ASAHI-CHO	
Internal Address:	OHTA-KU	
City:	TOKYO	
State/Country:	JAPAN	
Postal Code:	144-8510	

# **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14549744

## **CORRESPONDENCE DATA**

**Fax Number:** (312)616-5700

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 312-616-5600

Email: email@leydig.com

Correspondent Name: JOHN K. WINN

Address Line 1: TWO PRUDENTIAL PLAZA, SUITE 4900

Address Line 2: 180 NORTH STETSON AVENUE Address Line 4: CHICAGO, ILLINOIS 60601-6731

ATTORNEY DOCKET NUMBER:	719175/EKM
NAME OF SUBMITTER:	JOHN K. WINN
SIGNATURE:	/John K. Winn/
DATE SIGNED:	12/30/2014

#### **Total Attachments: 4**

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PATENT 503119290 REEL: 034602 FRAME: 0454

**PATENT** 

Attorney Docket No. 719175 Client Reference No. GEB3789-US

#### ASSIGNMENT

#### WHEREAS, I/WE

- (1) Keisuke SAKATA of Ebara Corporation, 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan,(2)
  - (4)

(3)

- (5)
- (6)

hereinafter referred to as Assignor, have invented a certain invention entitled:

# POLISHING APPARATUS

for which invention an application (non-provisional) for a U.S. patent was filed on November 21, 2014, under U.S. Application No. 14/549,744, and

WHEREAS, EBARA CORPORATION of 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, hereinafter referred to as Assignee, is desirous of acquiring the entire right, title, and interest in, to, and under the invention described in the patent application, including the entire priority right derived from the application,

Now, Therefore, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged,

Assignor assigns and transfers to Assignee and Assignee's legal representatives, successors, and assigns the entire right, title, and interest in, to, and under the invention, the referenced patent application, other such applications (e.g., provisional applications, non-provisional applications, continuations, continuations-in-part, divisionals, reissues, reexaminations, national and regional phase applications, petty patent applications, and utility model applications) that may be filed in the U.S. and/or any country foreign to the U.S. on the invention, the patents that may issue thereon, and the patents as may be modified as the result of applicable procedures (e.g., supplemental examinations, ex parte reexaminations, inter partes reexaminations, inter partes reviews, post-grant reviews, and oppositions),

Assignor conveys to the Assignee the right to make applications in Assignee's own behalf for protection of the invention in the U.S. and countries foreign to the U.S. and to claim priority to the referenced patent application and other such applications that may be filed in the U.S. or any

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country foreign to the U.S. on the invention under the Patent Cooperation Treaty, the Paris Convention, and any other international arrangements,

Assignor will not execute any writing or do any act conflicting with the terms of this assignment,

Assignor will at any time upon request, without further or additional consideration, but at the expense of the Assignee, execute such additional assignments and other writings and do such additional acts as the Assignee may deem necessary or desirable to pursue the patent applications identified herein, including, but not limited to, rendering all necessary assistance in making applications for and obtaining patents that may issue thereon in the U.S. and any countries foreign to the U.S. on the invention, and in enforcing any rights accruing as a result of such applications or patents, by, for example, executing statements and other affidavits,

Assignor and Assignee agree the terms of this assignment shall bind, and inure to the benefit of, the legal representatives, successors, and assigns of all parties hereto,

Assignor authorizes Assignee to insert in this assignment the number and filing date of the application if the number and filing date of the application are not recited herein at the time of execution of this assignment by any or all of the parties hereto,

Assignor and Assignee agree that U.S. law governs this assignment, and

Assignee acknowledges and accepts this assignment.

IN WITNESS WHEREOF, Assignor has hereunder set his/her hand on the date shown below.

Date December 9, 2014	Keisuke Sakata
	Assignor: Keisuke SAKATA
Date	
	Witness:
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Assignment - Witness (without assignee signature) [rev 2012 10 16]

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